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September 2016

FAN49103 — 2.5 A, 1.8 MHz, TinyPower™ I²C Buck-Boost Regulator

Features

- 24 μA Typical PFM Quiescent Current
- Above 95% Efficiency
- Total Layout Area = 11.61 mm²
- Input Voltage Range: 2.5 V to 5.5 V
- Maximum Continuous Load Current:
 - 3.0 A at $V_{OUT}=3.4 \text{ V}, V_{IN}=3.3 \text{ V}$
 - 2.5 A at V_{OLIT} =3.4 V, V_{IN} =3.0 V
 - 2.0 A at V_{OUT}=3.4 V, V_{IN}=2.5 V
- I²C Compatible Interface
- Programmable Output Voltage:
 - 2.8 V to 4.0 V in 25 mV Steps
- 1.8 MHz Fixed-Frequency Operation in PWM Mode
- Automatic / Seamless Step-up and Step-down Mode Transitions
- Forced PWM and Automatic PFM/PWM Mode Selection
- 0.5 µA Typical Shutdown Current
- Low Quiescent Current Pass-Through Mode
- Internal Soft-Start and Output Discharge
- Low Ripple and Excellent Transient Response
- Internally Set, Automatic Safety Protections (UVLO, OTP, SCP, OCP)
- Package: 20 Bump, 0.4 mm Pitch WLCSP

Applications

- Smart Phones
- Tablets, Netbooks[®], Ultra-Mobile PCs
- Portable Devices with Li-ion Battery
- 2G/3G/4G Power Amplifiers
- NFC Applications

Description

The FAN49103 is a high efficiency buck-boost switching mode regulator which accepts input voltages either above or below the regulated output voltage. Using full-bridge architecture with synchronous rectification, the FAN49103 is capable of delivering up to 2.5 A while regulating the output at 3.4 V. The FAN49103 exhibits seamless transition between step-up and step-down modes reducing output disturbances. The output voltage and operation mode of the regulator can be programmed through an I²C interface.

At moderate and light loads, Pulse Frequency Modulation (PFM) is used to operate the device in power-save mode to maintain high efficiency. In PFM mode, the part still exhibits excellent transient response during load steps. At moderate to heavier loads or Forced PWM mode, the regulator switches to PWM fixed-frequency control. While in PWM mode, the regulator operates at a nominal fixed frequency of 1.8 MHz, which allows for reduced external component values.

The FAN49103 is available in a 20-bump 1.615 mm x 2.015 mm with 0.4 mm pitch WLCSP.

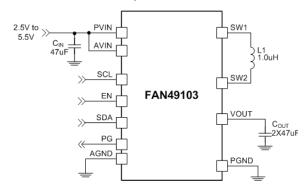


Figure 1. Typical Application

Ordering Information

Part Number	Output Discharge	Temperature Range	Package	Packing Method	Device Marking
FAN49103AUC340X	Yes	-40 to 85°C	20-Ball (WLCSP)	Tape and Reel	FC

Block Diagram

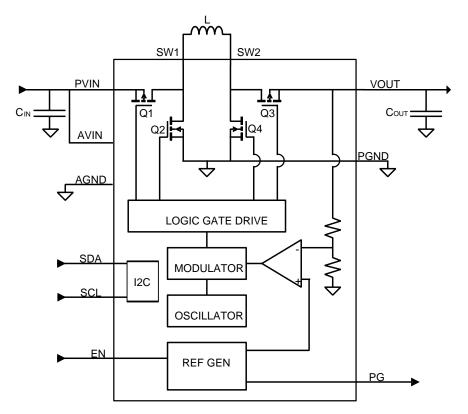


Figure 2. Block Diagram

Pin Configuration

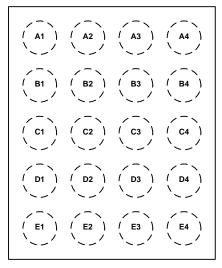


Figure 3. Top View (bump down)

Pin Definitions⁽¹⁾

Pin #	Name	Description
A3, A4	PVIN	Power Input Voltage. Connect to input power source. Connect to C _{IN} with minimal path.
A1	AVIN	Analog Input Voltage. Analog input for device. Connect to C _{IN} and PVIN.
A2	EN	Enable. A HIGH logic level on this pin forces the device to be enabled. A LOW logic level forces the device into shutdown. EN pin can be tied to VIN or driven via a GPIO logic voltage.
B3, B4	SW1	Switching Node 1. Connect to inductor L1.
E1	AGND	Analog Ground. Control block signal is referenced to this pin. Short AGND to PGND at GND pad of C _{OUT} .
B1, C1, C2, C3, C4, D1	PGND	Power Ground. Low-side MOSFET of buck and main MOSFET of boost are referenced to this pin. C _{IN} and C _{OUT} should be returned with a minimal path to these pins.
D2	SDA	I ² C Data Line. Used for I ² C communication.
D3, D4	SW2	Switching Node 2. Connect to inductor L1.
E2	PG	Power Good. This is an open-drain output and normally High Z. An external pull-up resistor from VOUT can be used to generate a logic HIGH. PG is pulled LOW if output falls out of regulation due to current overload or if thermal protection threshold is exceeded. If EN is LOW, PG is high impedance.
B2	SCL	I ² C Clock Line. Used for I ² C communication.
E3, E4	VOUT	Output Voltage. Buck-Boost Output. Connect to output load and Cout.

Note:

1. Refer to Layout Recommendation section located near the end of the datasheet.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Parameter					
PVIN/AVIN	PVIN/AVIN Voltage		-0.3	6.5	V		
VOUT	VOUT Voltage	-0.3	6.5	V			
SW1, SW2	SW Nodes Voltage	-0.3	7.0	V			
	Other Pins	-0.3	6.5	V			
ESD	Electrostatic Discharge	Human Body Model per JESD22-A114		000	V		
ESD	Protection Level Charged Device Model per JESD22-C101		1	000	V		
TJ	Junction Temperature	Junction Temperature					
T _{STG}	Storage Temperature	-65	+150	°C			
TL	Lead Soldering Tempera	ature, 10 Seconds		+260	°C		

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
PVIN	Supply Voltage Range	2.5		5.5	V
I _{OUT}	Output Current ⁽²⁾	0		2.5	Α
L	Inductor ⁽⁵⁾		1.0		μH
C _{IN}	Input Capacitance ^(2'3'4'5)	2	47		μF
C _{OUT}	Output Capacitance (2,3,4,5)	17	47		μF
T _A	Operating Ambient Temperature	-40		+85	°C
T _J	Operating Junction Temperature	-40		+125	°C

Notes:

- Depends on input and output voltages. Thermal properties of the device should be taken into consideration; refer to Thermal Consideration in the Application Information section.
- Typical value reflects the capacitor value needed to meet minimum requirement. Minimum passive component values indicate effective capacitance which includes temperature, voltage de-rating, tolerance, and stability.
- 4. Output capacitance affects load transient response and loop phase margin; see Application Information section.
- 5. Refer to Additional Application Information section.

Thermal Properties

Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p with vias JEDEC class boards in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature $T_{J(max)}$ at a given ambient temperature T_A .

Symbol	Parameter	Min.	Тур.	Max.	Unit
θ_{JA}	Junction-to-Ambient Thermal Resistance ⁽⁶⁾		66		°C/W

Note:

6. See Thermal Considerations in the Application Information section.

Electrical Characteristics⁽⁷⁾

Minimum and maximum values are at PVIN = AVIN = 2.5 V to 5.5 V, T_A = -40°C to +85°C. Typical values are at T_A = 25°C, PVIN = AVIN = V_{EN} = 3.6 V, VOUT = 3.4 V. (8)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
Power Su	pplies	-			•	II.	
	Quiescent Current	PFM Mode, $I_{OUT} = 0 \text{ mA}^{(9)}$		24			
lα	Quiescent Current	PT Mode, I _{OUT} = 0 mA		27		μA	
I _{SD}	Shutdown Supply Current	EN = GND, PVIN = 3.6 V		0.5	5.0	μA	
V _{UVLO}	Under-Voltage Lockout Threshold	Falling PVIN	1.95	2.00	2.05	V	
V _{UVHYST}	Under-Voltage Lockout Hysteresis			200		mV	
EN, SDA,	SCL						
V _{IH}	HIGH Level Input Voltage		1.1			V	
V_{IL}	LOW Level Input Voltage				0.4	V	
I _{IN}	Input Bias Current Into Pin	Input Tied to GND or PVIN		0.01	1.00	μA	
PG							
V_{PG}	PG LOW	$I_{PG} = 5 \text{ mA}$			0.4	V	
I _{PG_LK}	PG Leakage Current	$V_{PG} = 5 \text{ V}$			1	μA	
Switching]						
f _{SW}	Switching Frequency	PVIN = 3.6 V, T _A = 25°C	1.6	1.8	2.0	MHz	
I _{p_LIM}	Peak PMOS Current Limit	PVIN = 3.6 V	4.6	5.2	5.9	Α	
Accuracy							
V	DC Output Voltage Accuracy	PVIN = 3.6 V, Forced PWM, I _{OUT} = 0 mA, VOUT = 3.4 V	3.366	3.400	3.434	V	
V _{OUT_ACC}	DC Output Voltage Accuracy	PVIN = 3.6 V, PFM Mode, I _{OUT} = 0 mA, VOUT = 3.4 V	3.366	3.475	3.563		

Notes:

- 7. Refer to Typical Characteristics waveforms/graphs for Closed-Loop data and its variation with input voltage and ambient temperature. Electrical Characteristics reflects Open-Loop steady state data. System Characteristics reflects both steady state and dynamic Close-Loop data associated with the recommended external components.
- 8. Minimum and Maximum limits are verified by design, test, or statistical analysis. Typical (Typ.) values are not tested, but represent the parametric norm.
- 9. Device is not switching.

System Characteristics

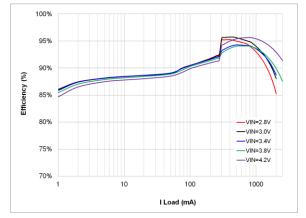
The following table is verified by design and bench test while using circuit of Figure 1 with the following external components: L = 1.0 μ H, DFE201612E-1R0M (TOKO), C_{IN} = 47 μ F, C_{OUT} = 2 x 47 μ F, 0603 (1608 metric) CL10A476MQ8NZNE (SEMCO). Typical values are at T_A = 25°C, PVIN = AVIN = V_{EN} = 3.6 V, VOUT = 3.4 V. These parameters are not verified in production.

Symbol	Parameter		Min.	Тур.	Max.	Unit	
V _{OUT_ACC}	Total Accuracy (Includes DC accuracy and load transient) ⁽¹⁰⁾			±5		%	
ΔV _{OUT}	Load Regulation	I _{OUT} = 0.4 A to 2.5 A, PVIN = 3.6 V		-0.20		%/A	
ΔV _{OUT}	Line Regulation	3.0 V ≤ PVIN ≤ 4.2 V, I _{OUT} = 1.5 A		-0.06		%/V	
		PVIN = 4.2 V, VOUT = 3.4 V, I _{OUT} = 1 A, PWM Mode		4			
V _{OUT_RIPPLE}	Ripple Voltage	PVIN = 3.6 V, VOUT = 3.4 V, I _{OUT} = 100 mA, PFM Mode		22		mV	
		PVIN = 3.0 V, VOUT = 3.4 V, I _{OUT} = 1 A, PWM Mode		14			
		PVIN = 3.0 V, VOUT = 3.4 V, I _{OUT} = 50 mA, PFM		90			
	Efficiency	PVIN = 3.0 V, VOUT = 3.4 V, I _{OUT} = 500 mA, PWM		96			
η		PVIN = 3.8 V, VOUT = 3.4 V, I _{OUT} = 50 mA, PFM		90		%	
		PVIN = 3.8 V, VOUT = 3.4 V, I _{OUT} = 600 mA, PWM		94			
		PVIN = 3.4 V, VOUT = 3.4 V, I _{OUT} = 300 mA, PWM		94			
T _{SS}	Soft-Start	EN HIGH to 95% of Target VOUT, I _{OUT} = 68 mA		260		μs	
		PVIN = 3.4 V, I_{OUT} = 0.5 A \Leftrightarrow 1 A, T_R = T_F = 1 μ s		±45			
ΔV_{OUT_LOAD}	Load Transient	PVIN = 3.4 V, I_{OUT} = 0.5 A \Leftrightarrow 2.0 A, T_R = T_F = 1 μ s, Pulse Width = 577 μ s		±125		mV	
$\Delta V_{ extsf{OUT_LINE}}$	Line Transient	PVIN = 3.0 V \Leftrightarrow 3.6 V, T _R = T _F = 10 μ s, l _{OUT} = 1 A		±60		mV	

Note:

10. Load transient is from 0.5 A <-> 1 A.

Typical Characteristics



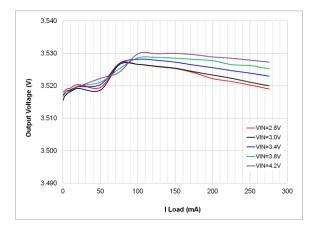


Figure 4. Efficiency vs. Load

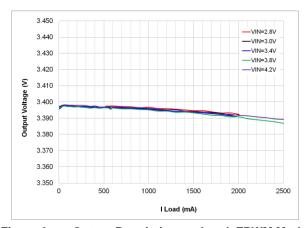


Figure 5. Output Regulation vs. Load

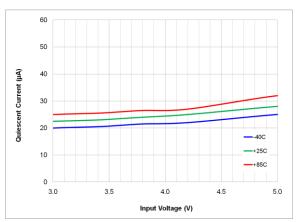


Figure 6. Output Regulation vs. Load, FPWM Mode

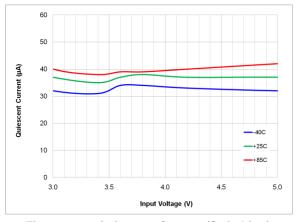


Figure 7. Quiescent Current (No Switching) vs. Input Voltage

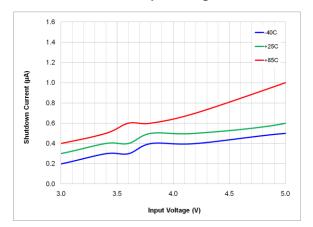
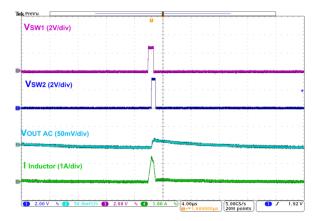


Figure 8. Quiescent Current (Switching) vs. Input Voltage

Figure 9. Shutdown Current vs. Input Voltage



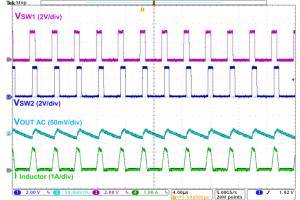
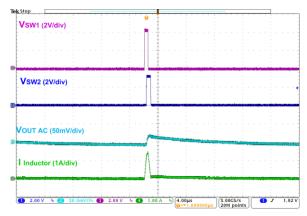


Figure 10. Output Ripple, VIN = 2.8 V, I_{OUT} = 20 mA, Boost Operation

Figure 11. Output Ripple, VIN = 3.3 V, I_{OUT} = 200 mA, Buck-Boost Operation



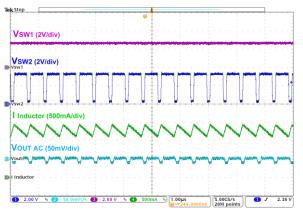
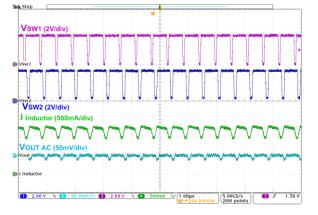


Figure 12. Output Ripple, VIN = 4.2 V, I_{OUT} = 20 mA, Buck Operation

Figure 13. Output Ripple, VIN = 2.5 V, I_{OUT} = 1000 mA, Boost Operation



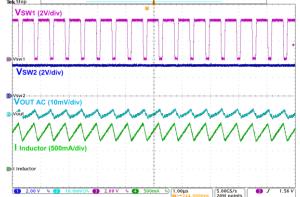
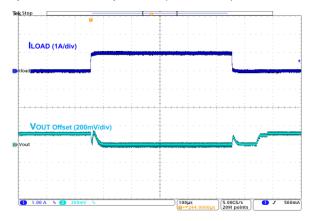


Figure 14. Output Ripple, VIN = 3.3 V, I_{OUT} = 1000 mA, Buck-Boost Operation

Figure 15. Output Ripple, VIN = 4.5 V, I_{OUT} = 1000 mA, Buck Operation



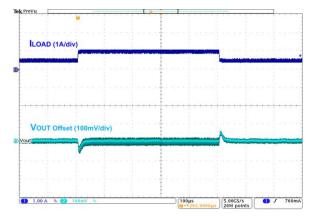
ILOAD (1A/div)

Vout Offset (100mV/div)

Vout

Figure 16. Load Transient, 0 mA <--> 1000 mA, 1 µs Edge, VIN = 3.60 V

Figure 17. Load Transient, 500 mA <--> 1500 mA, 1 μ s Edge, VIN = 3.60 V



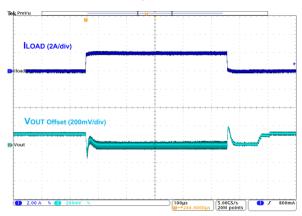
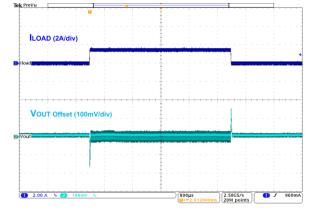


Figure 18. Load Transient, 500 mA <--> 1000 mA, 1 μ s Edge, VIN = 3.40 V

Figure 19. Load Transient, 0 mA <--> 2000 mA, 1 μ s Edge, VIN = 3.60 V



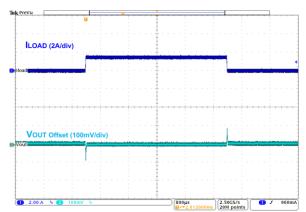
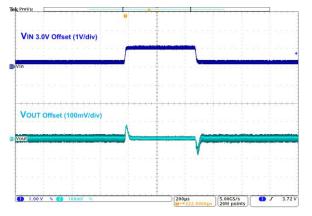


Figure 20. Load Transient, 0 mA <--> 1500 mA, 10 µs Edge, VIN = 2.80 V, PWM Mode

Figure 21. Load Transient, 0 mA <--> 1500 mA, 10 µs Edge, VIN = 4.20 V, PWM Mode



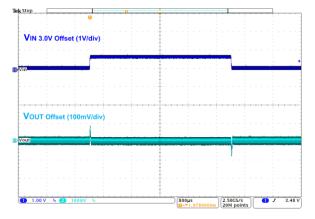
Vin 3.0V Offset (500mV/div)

Vout Offset (100mV/div)

Soomv to least (2.50cs/s) 3.48V

Figure 22. Line Transient, 3.2 <--> 4.0 VIN, 10 μs Edge, 1000 mA Load

Figure 23. Line Transient, 3.0 <--> 3.6 VIN, 10 μ s Edge, 1500 mA Load, PWM



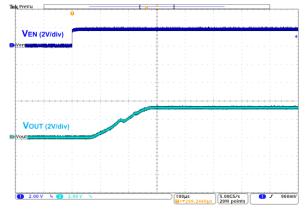
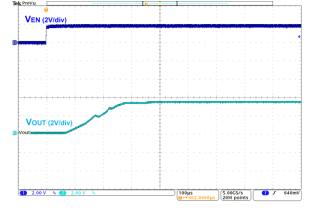


Figure 24. Line Transient, 3.0 <--> 3.6 VIN, 10 μs Edge, 1000 mA Load, PWM

Figure 25. Startup, VIN = 3.6 V, I_{OUT} = 0 mA



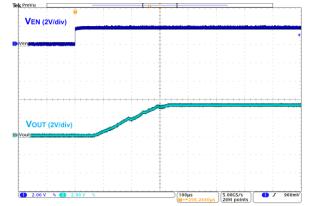
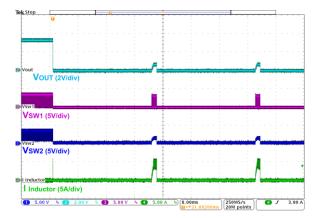


Figure 26. Startup, VIN = 3.6 V, I_{OUT} = 68 mA

Figure 27. Startup, VIN = 3.6 V, I_{OUT} = 1000 mA



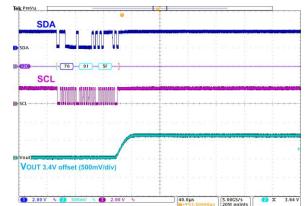
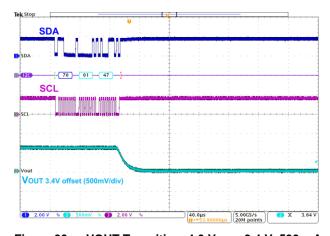


Figure 28. Short-Circuit Protection

Figure 29. VOUT Transition, 3.4 V <--> 4.0 V, 500 mA Load



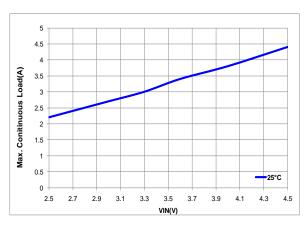


Figure 30. VOUT Transition, 4.0 V <--> 3.4 V, 500 mA Load

Figure 31. Typical Maximum Continuous Load vs. Input Voltage, V_{OUT} = 3.4 V, 25°C

Application Information

Functional Description

FAN49103 is a fully integrated synchronous, full bridge DC-DC converter that can operate in buck operation (during high PVIN), boost operation (for low PVIN) and a combination of buck-boost operation when PVIN is close to the target VOUT value. The PWM/PFM controller switches automatically and seamlessly between buck, buck-boost and boost modes.

The FAN49103 uses a four-switch operation during each switching period when in the buck-boost mode. Mode operation is as follows: referring to the power drive stage shown in Figure 32 if PVIN is greater than target VOUT, then the converter is in buck mode: Q3 is ON and Q4 is OFF continuously leaving Q1, Q2 to operate as a current-mode controlled PWM converter. If PVIN is lower than target VOUT then the converter is in boost mode with Q1 ON and Q2 OFF continuously, while leaving Q3, Q4 to operate as a current-mode boost converter. When PVIN is near VOUT, the converter goes into a 3-phase operation in which combines a buck phase, a boost phase and a reset phase; all switches are switching to maintain an average inductor volt-second balance.

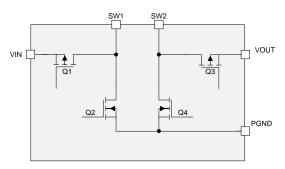


Figure 32. Simplified Block Diagram

PFM/PWM Mode

The FAN49103 uses a current-mode modulator to achieve smooth transitions between PWM and PFM operation. In Pulsed Frequency Modulation (PFM), frequency is reduced to maintain high efficiency. During PFM operation, the converter positions the output voltage typically 75 mV higher than the nominal output voltage during PWM operation, allowing additional headroom for voltage drop during a load transient from light to heavy load. As the load increased from light loads, the converter enters PWM operation typically at 300 mA of current load. The converter switching frequency is typically 1.8 MHz during PWM operation for moderate to heavy load currents.

PT (Pass-Through) Mode

In Pass-Through mode, all of the switches are not switching and VOUT tracks PVIN (VOUT = PVIN $-I_{\text{OUT}}$ *(Q1_RDSON + Q3_RDSON +LDCR) In PT mode only Over-Temperature (OTP) and Under Voltage Lockout (UVLO) protection circuits are activated. There is no Over-Current Protection (OCP) in PT mode.

Shutdown and Startup

When the EN pin is LOW, the IC is shut down, all internal circuits are off, and the part draws very little current. During shutdown, VOUT is isolated from PVIN. Raising EN pin activates the device and begins the soft-start cycle. During soft-start, the modulator's internal reference is ramped slowly to minimize surge currents on the input and prevent overshoot of the output voltage. If VOUT fails to reach target VOUT value after 1ms, a FAULT condition is declared.

Over-Temperature (OTP)

The regulator shuts down when the die temperature exceeds 150°C. Restart occurs when the IC has cooled by approximately 20°C.

Output Discharge

When the regulator is disabled and driving the EN pin LOW, a 230 Ω internal resistor is activated between VOUT and GND. The Output Discharge is not activated during a FAULT state condition.

Over-Current Protection (OCP)

If the peak current limit is activated for a typical 700 µs, a FAULT state is generated, so that the IC protects itself as well as external components and load.

FAULT State

The regulator enters the FAULT state under any of the following conditions:

- VOUT fails to achieve the voltage required after soft-start.
- Peak current limit triggers.
- OTP or UVLO are triggered.

Once a FAULT is triggered, the regulator stops switching and presents a high-impedance path between PVIN and VOUT. After waiting 30 ms, a restart is attempted.

Power Good

PG, an open-drain output, is LOW during FAULT state and HIGH for Power Good.

The PG pin is provided for signaling the system when the regulator has successfully completed soft-start and no FAULTs have occurred. PG pin also functions as a warning flag for high die temperature and overload conditions.

- PG is released HIGH when the soft-start sequence is successfully completed.
- PG is pulled LOW when a FAULT is declared.

Any FAULT condition causes PG to be de-asserted.

Thermal Considerations

For best performance, the die temperature and the power dissipated should be kept at moderate values. The maximum power dissipated can be evaluated based on the following relationship:

$$P_{D(\text{max})} = \left\{ \frac{T_{J(\text{max})} - T_A}{\Theta_{JA}} \right\} \tag{1}$$

where $T_{J(max)}$ is the maximum allowable junction temperature of the die; T_A is the ambient operating temperature; and θ_{JA} is dependent on the surrounding PCB layout and can be improved by providing a heat sink of surrounding copper ground.

The addition of backside copper with through-holes, stiffeners, and other enhancements can help reduce $\theta_{\rm JA}.$ The heat contributed by the dissipation of devices nearby must be included in design considerations. Following the layout recommendation may lower the $\theta_{\rm JA}.$

I²C Interface

The FAN49103's serial interface is compatible with Standard, Fast, Fast Plus, and HS Mode I²C-Bus® specifications. The SCL line is an input and its SDA line is a bi-directional open-drain output; it can only pull down the bus when active. The SDA line only pulls LOW during data reads and when signaling ACK. All data is shifted in MSB (bit 7) first.

I²C Slave Address

In hex notation, the slave address assumes a 0 LS Bit. The hex slave address is E0.

Table 1. I²C Slave Address

Цох					Bits			
Hex	7	6	5	4	3	2	1	0
E0	1	1	1	0	0	0	0	R/W

Bus Timing

As shown in Figure 33, data is normally transferred when SCL is LOW. Data is clocked in on the rising edge of SCL. Typically, data transitions shortly at or after the falling edge of SCL to allow ample time for the data to set up before the next SCL rising edge.

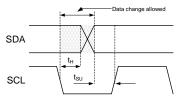


Figure 33. Data Transfer Timing

Each bus transaction begins and ends with SDA and SCL HIGH. A transaction begins with a START condition, which is defined as SDA transitioning from 1 to 0 with SCL HIGH, as shown in Figure 34.

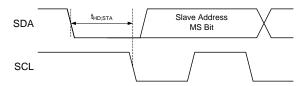


Figure 34. START Bit

A transaction ends with a STOP condition, which is defined as SDA transitioning from 0 to 1 with SCL HIGH, as shown in Figure 35.

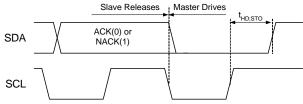


Figure 35. STOP Bit

During a read from the FAN49103, the master issues a REPEATED START after sending the register address, and before resending the slave address. The REPEATED START is a 1 to 0 transition on SDA while SCL is HIGH, as shown in Figure 36.

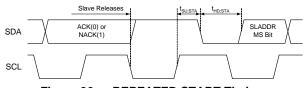


Figure 36. REPEATED START Timing

High-Speed (HS) Mode

The protocols for High-Speed (HS), Low-Speed (LS), and Fast-Speed (FS) Modes are identical; except the bus speed for HS mode is 3.4 MHz. HS Mode is entered when the bus master sends the HS master code 00001XXX after a START condition. The master code is sent in Fast or Fast-Plus Mode (less than 1 MHz clock); slaves do not ACK this transmission.

The master generates a REPEATED START condition (Figure 34) that causes all slaves on the bus to switch to HS Mode. The master then sends I2C packets, as described above, using the HS Mode clock rate and timing.

The bus remains in HS Mode until a STOP bit (Figure 35) is sent by the master. While in HS Mode, packets are separated by REPEATED START conditions (Figure 36).

Read and Write Transactions

The following figures outline the sequences for data read and write. Bus control is signified by the shading of the packet, defined as Master Drives Bus and Slave Drives Bus. All addresses and data are MSB first.

Table 2. I²C Bit Definitions for Figure 37 & Figure 38

Symbol	Definition
R	REPEATED START, see Figure 36
Р	STOP, see Figure 35
S	START, see Figure 34
Α	ACK. The slave drives SDA to 0 to acknowledge the preceding packet.
Ā	NACK. The slave sends a 1 to NACK the preceding packet.
R	REPEATED START, see Figure 36.
Р	STOP, see Figure 35.



Figure 37. Write Transaction

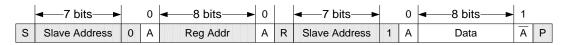


Figure 38. Read Transaction

Register Description

Table 3. Register Table

Hex Address	Name	Function
00	SOFT-RESET	Resets all registers to default values.
01	VOUT_REF	Set the target regulation point of VOUT.
02	CONTROL	PT and MODE control.
40	Manufacturer_ID	Read-only register identifies vendor and device type.
41	Device_ID	Read-only register identifies die ID.

Bit Definitions

The following table defines the operation of each register bit. **Bold** indicates power-on default values.

Reserved Procession	Bit	Name	Value		-	Descript	ion				
O Soft_reset O Write 1 to reset all registers.	SOF	T-RESET W		Register Ac	Idress: 00						
VOUT_REF RW	7:1	Reserved	0000000								
Table	0	Soft_reset	0	Write 1 to res	et all registers.						
Sets the target regulation point for VOUT. HEX VOUT HEX HEX	VOU	T_REF R/V	٧	Register Ac	Idress: 01						
HEX	7	Reserved	0								
Bef_dac_code 1000111 1000111 100011 100011 100011 100011 100011 1000011 1000011 1000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 10000011 100000011 1000001				Sets the targe	et regulation point for	VOUT.					
2F 2.800				HEX	VOUT		HEX	VOUT			
30 2.825 49 3.450 31 2.850 4A 3.475 32 2.875 4B 3.500 33 2.900 4C 3.525 34 2.925 4D 3.550 34 2.925 4D 3.550 35 2.950 4E 3.575 36 2.975 4F 3.600 37 3.000 50 3.625 38 3.025 51 3.650 39 3.095 52 3.675 38 3.100 54 3.726 39 3.150 56 3.775 38 3.100 54 3.725 3D 3.150 56 3.775 3E 3.175 57 3.800 37 3.200 58 3.825 40 3.225 59 3.850 41 3.250 5A 3.875 42 3.275 5B 3.900 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 60 - 7F Reserved CONTROL RW Register Address: 02 Toda Reserved 00 Reserved 00 Regulated output (Boost, Buck or Buck-Boost) 1 Pass-Through mode 2				00 - 2E	Reserved		47	3.400			
Second Process of P				2F	2.800		48	3.425			
Second				30	2.825		49	3.450			
Second				31	2.850		4A	3.475			
Ref_dac_code Ref_dac_code Ref_dac_code Ref_dac_code 1000111				32	2.875		4B	3.500			
Ref_dac_code Nef_dac_code Nef				33	2.900		4C	3.525			
Ref_dac_code Ref_				34	2.925		4D	3.550			
6:0 Ref_dac_code Ref_dac_code				35	2.950		4E	3.575			
Ref_dac_code				36	2.975		4F	3.600			
Ref_dac_code				37	3.000		50	3.625			
Nel_dac_code				38	3.025		51	3.650			
3A 3.075 53 3.700	6.0	Dof dog god-	1000111	39	3.050		52	3.675			
3C 3.125 55 3.750 3D 3.150 56 3.775 3E 3.175 57 3.800 3F 3.200 58 3.825 40 3.225 59 3.850 41 3.250 5A 3.875 42 3.275 5B 3.990 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 60 - 7F Reserved 3 12c_pt_in 0 Enables Pass-Through mode. Code Mode 0 Regulated output (Boost, Buck or Buck-Boost) 1 Pass-Through enabled Code Mode 0 Regulated output (Boost, Buck or Buck-Boost) 1 Pass-Through enabled Code Mode 0 Auto PWM - PFM mode based on load 1 Forced PWM mode enabled 1 Forced PWM mode enabled 1 Reserved 00 Manufacture_ID R Register Address: 40 Register Address: 41 Register Address: 41	0.0	Rei_dac_code	1000111	3A	3.075		53	3.700			
3D 3.150 56 3.775 3.800 3F 3.200 58 3.825 40 3.225 59 3.850 41 3.250 5A 3.875 42 3.275 5B 3.900 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 4 4 4 4 4 4 4 4				3B	3.100		54	3.725			
3E 3.175 57 3.800 3F 3.200 58 3.825 40 3.225 59 3.850 41 3.250 5A 3.875 42 3.275 5B 3.900 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 4 60 - 7F Reserved 7:4 Reserved 0000 3 2				3C	3.125		55	3.750			
3F 3.200 58 3.825 40 3.225 59 3.850 41 3.250 5A 3.875 42 3.275 5B 3.900 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 60 - 7F Reserved 7:4 Reserved 0000 8 Register Address: 02 12c_pt_in 0 Enables Pass-Through mode. Code				3D	3.150		56	3.775			
40 3.225 59 3.850 41 3.250 5A 3.875 42 3.275 5B 3.900 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4				3E	3.175		57	3.800			
41 3.250 5A 3.875 42 3.275 5B 3.900 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 4 60 - 7F Reserved 7:4 Reserved 0000				3F	3.200		58	3.825			
42 3.275 5B 3.900 43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 60 - 7F Reserved 7:4 Reserved 0000 8				40	3.225		59	3.850			
43 3.300 5C 3.925 44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4				41	3.250		5A	3.875			
44 3.325 5D 3.950 45 3.350 5E 3.975 46 3.375 5F 4 46 3.375 60 - 7F Reserved 7:4 Reserved 0000				42	3.275		5B	3.900			
45 3.350 5E 3.975 46 3.375 60 - 7F Reserved				43	3.300		5C	3.925			
46 3.375 5F 4 60 - 7F Reserved 7:4 Reserved 0000 3				44	3.325		5D	3.950			
CONTROL R/W Register Address: 02 7:4 Reserved 0000 Enables Pass-Through mode. Code Mode 0 Regulated output (Boost, Buck or Buck-Boost) 1 Pass-Through enabled Enables Forced PWM mode, as long as Pass-Through is not enabled. Code Mode 0 Auto PWM - PFM mode based on load 1 Forced PWM mode enabled 1:0 Reserved 00 Manufacture_ID R Register Address: 40 7:0 Manufacture_ID R Register Address: 41 Register Address: 41				45	3.350		5E	3.975			
CONTROL R/W Register Address: 02 7:4 Reserved 0000 2 Enables Pass-Through mode. 2 Enables Pass-Through mode. Code Mode 0 Register Address: 40 No Provice ID R Register Address: 41				46	3.375			4			
7:4 Reserved 0000 3 i2c_pt_in 6 Enables Pass-Through mode. 2 i2c_pt_in 0 Enables Pass-Through mode. 2 Enables Forced PWM mode, as long as Pass-Through is not enabled. Code Mode 0 Auto PWM - PFM mode based on load 1 Forced PWM mode enabled 1:0 Reserved 00 Manufacture_ID R Register Address: 40 7:0 Manufacture_ID 10000011 Device_ID R Register Address: 41							60 - 7F	Reserved			
Benables Pass-Through mode. Code Mode 0 Regulated output (Boost, Buck or Buck-Boost) 1 Pass-Through enabled Enables Forced PWM mode, as long as Pass-Through is not enabled. Code Mode Code Mode O Auto PWM - PFM mode based on load 1 Forced PWM mode enabled 1:0 Reserved 00 Manufacturer_ID R Register Address: 40 7:0 Manufacture_ID R Register Address: 41	CON	TROL R/V	V	Register Ac	ldress: 02						
Code	7:4	Reserved	0000								
3 i2c_pt_in 0 Regulated output (Boost, Buck or Buck-Boost) 1 Pass-Through enabled 2 i2c_mode_in Enables Forced PWM mode, as long as Pass-Through is not enabled. Code Mode 0 Auto PWM - PFM mode based on load 1:0 Reserved 00 Register Address: 40 7:0 Manufacture_ID 10000011 Device_ID Register Address: 41				l 	-Through mode.						
0 Regulated output (Boost, Buck or Buck-Boost) 1	3	i2c nt in	0	Code	Code Mode						
Enables Forced PWM mode, as long as Pass-Through is not enabled. Code		120_pt_111		0			ck-Boost)				
Code Mode 0 Auto PWM - PFM mode based on load 1:0 Reserved 0 Forced PWM mode enabled 1:0 Reserved 0 Register Address: 40 7:0 Manufacture_ID 10000011 Device_ID R Register Address: 41				-	J.						
2 i2c_mode_in 0 Auto PWM - PFM mode based on load 1:0 Reserved 00 Manufacturer_ID R Register Address: 40 7:0 Manufacture_ID 10000011 Device_ID R Register Address: 41					ed PWM mode, as lo	_		nabled.			
0 Auto PWM - PFM mode based on load 1 Forced PWM mode enabled 1:0 Reserved 00	2	i2c mode in	0	Code		<u> </u>	/lode				
1:0 Reserved 00 Manufacturer_ID R Register Address: 40 7:0 Manufacture_ID 10000011 Device_ID R Register Address: 41	-						ad				
Manufacturer_ID_R Register Address: 40 7:0 Manufacture_ID 10000011 10000011 Device_ID R Register Address: 41 Register Address: 41				1	Forced PWM mod	le enabled					
7:0 Manufacture_ID 10000011			00								
Device_ID R Register Address: 41				Register Ac	Idress: 40						
			10000011								
				Register Ac	Idress: 41						
7:0 Device_ID 00000110	7:0	Device_ID	00000110								

Additional Application Information

Table 4. Recommended Capacitors

Capacitor	Part Number	Vendor	Value	Case Size	Rating
C _{IN}	CL10A476MQ8NZNE	SEMCO	47 μF	0603 (1608 Metric)	6.3 V
C _{OUT}	CL10A476MQ8NZNE	SEMCO	2 x 47 µF	0603 (1608 Metric)	6.3 V

Output Capacitance (Cout) and Input Capacitance (CIN) Stability

The effective capacitance (C_{EFF}) of small, high-value, ceramic capacitors will decrease as bias voltage increases. FAN49103 is guaranteed for stable operation with the minimum value of 17 μ F ($C_{EFF(MIN)}$) output capacitance when using a 1 μ H value inductor and a minimum value of 13 μ F ($C_{EFF(MIN)}$) output capacitance when using a 0.47 μ H value inductor. Furthermore, FAN49103 is guaranteed for stable operation with the minimum value of 2 μ F ($C_{EFF(MIN)}$) input capacitance. De-rating factors should be taken into consideration to ensure selected components meet minimum requirement.

Table 5. Minimum C_{FFF}⁽¹¹⁾ Required for Stability

VOUT (V)	I _{LOAD} (A)	Inductor Value	C _{EFF(MIN)}	
3.4 V	0 – 2.5 A	1.0 µH	17 µF	
3.4 V	0 – 2.5 A	0.47 µH	13 µF	

Note:

11. C_{EFF} is defined as the capacitance value during operating conditions and not the capacitor value. A capacitor varies with manufacturer, material, case size, voltage rating and temperature.

Inductor Selection

Recommended nominal inductance value is $1.0\,\mu\text{H}$. An inductor value of $0.47\,\mu\text{H}$ can be used but higher peak currents could lead to lower efficiency; however, transient response performance may be improved. FAN49103 employs peak current limiting and the peak inductor current can reach typically $5.2\,\text{A}$ for a short duration during overload conditions. Therefore, current saturation value should be taken into consideration when choosing an inductor.

Table 6. Recommended Inductors

Part Number	Vendor	Value	Dimension	Isat	DCR
DFE201610E1R0M		4.0	2.0 mm x 1.6 mm x 1.0 mm	3.9 A	48 mΩ
DFE201612E1R0M	TOKO	1.0 µH	2.0 mm x 1.6 mm x 1.2 mm	4.4 A	40 mΩ
DFE201610ER47M	TOKO	0.47 μH ⁽¹²⁾ (Optional)	2.0 mm x 1.6 mm x 1.0 mm	5.3 A	26 mΩ
DFE201612ER47M			2.0 mm x 1.6 mm x 1.2 mm	6.1 A	20 mΩ

Note:

12. When using 0.47 μ H inductor value, one 47 μ F (CL10A476MQ8NZNE) capacitor can be used at the output of the regulator.

Layout Recommendations

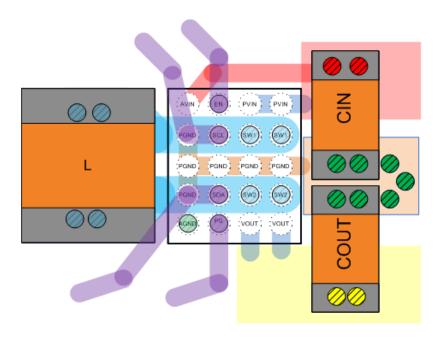


Figure 39. Component Placement and Routing for FAN49103

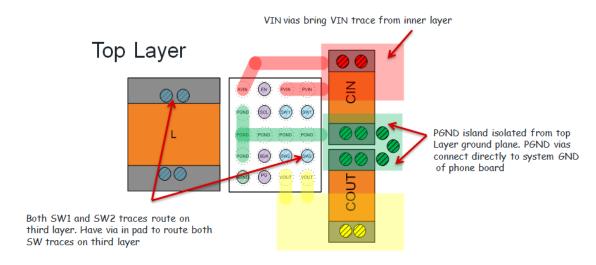


Figure 40. Top Layer Routing for FAN49103

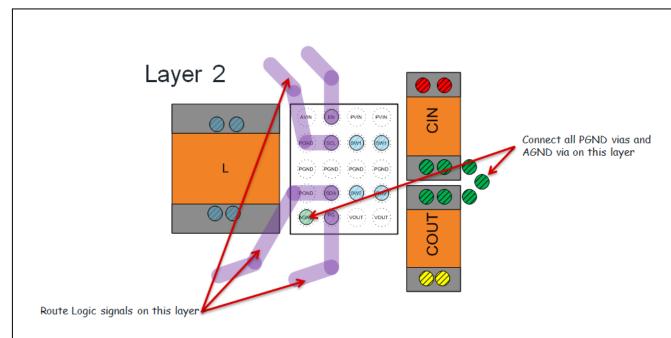


Figure 41. Layer 2 Routing for FAN49103

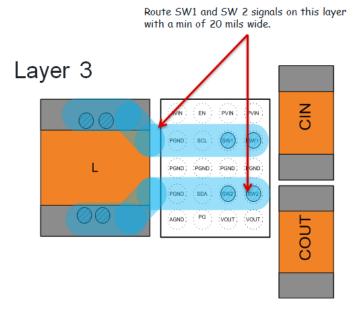
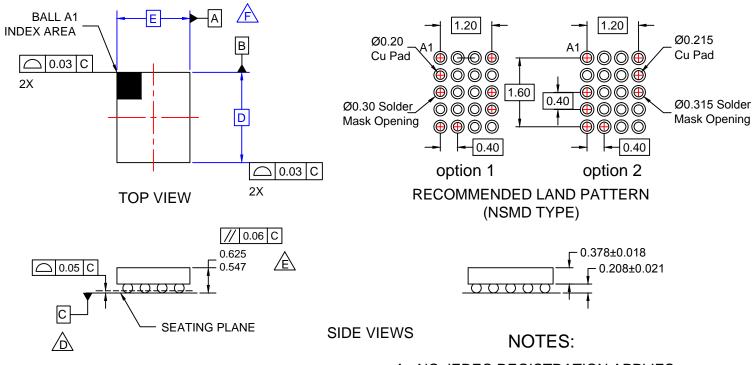


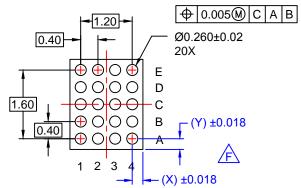
Figure 42. Layer 3 Routing for FAN49103

Physical Dimensions

This table information applies to the Package drawing on the following page.

Product	D	E	Х	Y
FAN49103AUC340X	2.015 ±0.030	1.615 ±0.030	0.2075	0.2075





BOTTOM VIEW

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 2009.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- PACKAGE NOMINAL HEIGHT IS 586 MICRONS ±39 MICRONS (547-625 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC020AArev4.



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